# Cryogenic MEMS Technology for Sensing Applications, Phase I

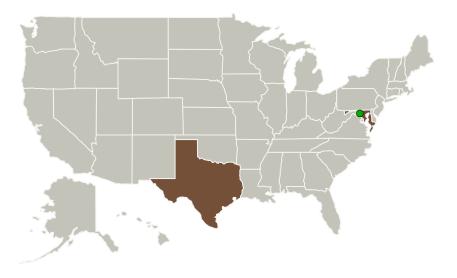


Completed Technology Project (2011 - 2011)

#### **Project Introduction**

The development of cryogenic microwave components, such as focal plane polarization modulators, first requires an RF MEMS switching technology that operates effectively at cryogenic temperatures. The approach of this project is to explore the performance of capacitive MEMS switching technology at low temperatures. MEMS capacitive switches represent an alternative to ohmic contact switches, where the RF impedance of the device is not dependent on metal-metal contacts. These MEMS switches operate with much lower effective series resistance (generally ~ 0.25 ohms) and do not have the issues associated with dry contact switching. This technology also has the advantage of operating very well at millimeter-wave frequencies and higher, where many of the most demanding performance limitations exist. This technology has seen significant investment through DARPA and the DOD, and is directly applicable to high-performance microwave components needed in several of the upcoming NASA missions.

#### **Primary U.S. Work Locations and Key Partners**



Organizations Performing Work	Role	Туре	Location
MEMtronics Corporation	Lead Organization	Industry	Plano, Texas
Goddard Space Flight Center(GSFC)	Supporting Organization	NASA Center	Greenbelt, Maryland



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#### Small Business Innovation Research/Small Business Tech Transfer

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Primary U.S. Work Locations	
Maryland	Texas

#### **Project Transitions**

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February 2011: Project Start



September 2011: Closed out

**Closeout Summary:** Cryogenic MEMS Technology for Sensing Applications, Pha se I Project Image

#### **Closeout Documentation:**

• Final Summary Chart Image(https://techport.nasa.gov/file/138068)

# Organizational Responsibility

# Responsible Mission Directorate:

Space Technology Mission Directorate (STMD)

#### **Lead Organization:**

**MEMtronics Corporation** 

#### **Responsible Program:**

Small Business Innovation Research/Small Business Tech Transfer

### **Project Management**

#### **Program Director:**

Jason L Kessler

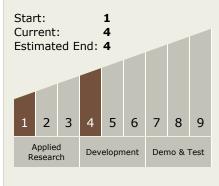
#### **Program Manager:**

Carlos Torrez

#### **Principal Investigator:**

Chuck Goldsmith

# Technology Maturity (TRL)





Small Business Innovation Research/Small Business Tech Transfer

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# **Technology Areas**

#### **Primary:**

- TX08 Sensors and Instruments
  - ☐ TX08.1 Remote Sensing Instruments/Sensors
    - ☐ TX08.1.1 Detectors and Focal Planes

# **Target Destinations**

The Moon, Mars, Outside the Solar System, The Sun, Earth, Others Inside the Solar System

